



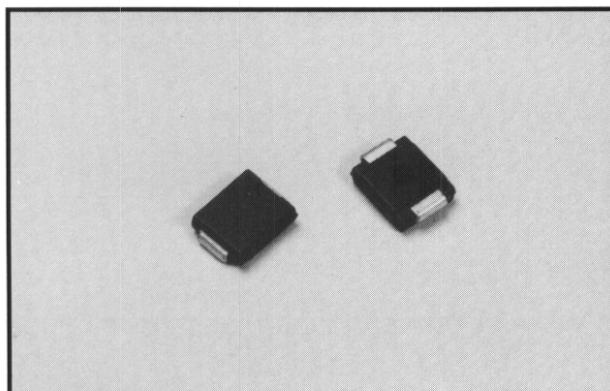
3 AMP SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

■ FEATURES

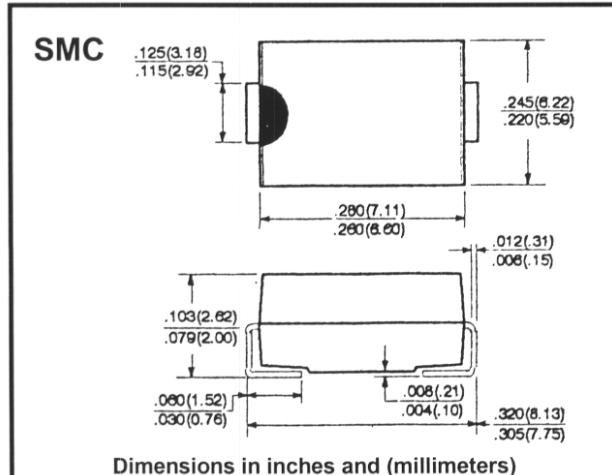
- For surface mount applications
- Metal semiconductor junction with guard ring
- Epitaxial construction
- Low forward voltage drop
- UL recognized 94V-O plastic material
- Lead solderable per MIL-STD-202 Method 208
- Surge overload rating to 100A peak

■ Mechanical Data

- Case: Molded plastic
- Polarity: Indicated on cathode
- Weight: 0.007 ounces, 0.21 grams



■ Outline Drawing



Dimensions in inches and (millimeters)

■ Maximum Ratings & Characteristics

- Ratings at 25° C ambient temperature unless otherwise specified
- Single phase, half wave, 60Hz, resistive or inductive load
- For capacitive load, derate current by 20%

		B320	B330	B340	B350	B360	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	20	30	40	50	60	V
Maximum RMS Input Voltage	V _{RMS}	14	21	28	35	42	V
Maximum DC Blocking Voltage	V _{DC}	20	30	40	50	60	V
Maximum Average Forward Output Current .375" 9.5mm lead length @ T _L = 110 °C	I _(AV)			3.0			A
Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave Superimposed On Rated Load	I _{FSM}			100			A
Maximum Forward Voltage Drop At 3.0A	V _F		0.50		0.70		V
Maximum Reverse Current At Rated @ T _A = 25°C	I _R			0.5			mA
DC Blocking Voltage per Bridge Element @ T _A = 100°C				20			mA
Typical Junction Capacitance* (See Note)	C _J			300			pF
Typical Thermal Resistance** (See Note)	R _(THJL)			10			°C/W
Maximum Thermal Resistance** (See Note)	R _(THJA)			50			°C/W
Operating Temperature Range	T _J			-65 to +125			°C
Storage Temperature Range	T _{STG}			-65 to +150			°C

Note: *Measured at 1.0 MHZ and applied reverse voltage of 4.0V DC

**Thermal resistance junction to lead/ambient measured on PC board 8mm² X (0.013mm thick)